

Atty. Dkt. No. 039153-0683 (H1721)

Amendments to the Specification:

Please amend the specification as follows:

Please replace paragraph starting at page 9, paragraph number [0036] with the following rewritten paragraph:

[0036] Material 38 can be deposited in a conformal layer deposition process such as by plasma enhanced chemical vapor deposition or sputter deposition. Material 38 preferably has a thickness greater than or equal to one half the width associates with trenches 36 or 250-1000 Angstroms (Å) or more thick in a preferred embodiment Angstroms thick. For SiN, the deposition parameters of material 38 can be Silane (SiH₄) + Ammonia (NH₃) + Nitrogen (N₂) using a pressure of 10-1000 MilliTorr, an rf power of 10-1000W, and a temperature of 100-500C ~~500C~~. Preferably, material 38 naturally compresses after deposition.